

REFRENSI

- Boothroyd, G., Dewhurst, P., Knight, W.A. (2011). *Product Design for Manufacture and Assembly Third Edition*. New York: Taylor & Francis Group.
- Edi, D. (2005). Seputar Personal Digital Assistant. *Jurnal Informatika UKM*, Vol 1 pp. 31-43.
- Erhard, G. (2006). *Designing with Plastic*. Munich: Carl Hanser Verlag.
- Falani, Z. (2013). *Analisis kelayakan*. Retrieved Februari 21, 2017. From [http://mfile.narotama.ac.id/files/Zakki%20Falani/Magang%20PDF/analisis kelayakan](http://mfile.narotama.ac.id/files/Zakki%20Falani/Magang%20PDF/analisis%20kelayakan).
- Firman. (2016). *Survei: Orang Indonesia Gemar Ganti Ponsel Setiap 1-2 Tahun*. Retrieved Februari 22, 2017 from <https://tekno.tempo.co/read/777292/survei-orang-indonesia-gemar-ganti-ponsel-setiap-1-2-tahun>.
- Gramatyka, P., Nowosielki, R. & Sakiewicz, P. (2007). Recycling of Waste Electrical and Electronic Equipment. *Journal of Achievements of Materials and Manufacturing Engineering Vol 20 pp. 535-538*.
- Gungor, A. (2006). Evaluation of connection types in design for disassembly (DFD) using analytic network process. *Computers & Industrial Engineering*, Vol 50 pp. 35–54.
- Handra, N & Bazi. (2012). Pengaruh Posisi Baut Galvanis Dan Stainless Steel Ditinjau Dari Fracture Surface Pada Sambungan Plat. *Jurnal Teknik Mesin Vol 2 pp. 26-34*.
- Jehan, N. (2012). *Kandungan berbahaya dalam E-waste*. Retrieved Februari 22, 2017 from [http://ylki.or.id/2012/09/kandungan-berbahayadalam-e waste](http://ylki.or.id/2012/09/kandungan-berbahayadalam-e%20waste).
- Johnson, M.R. & McCarthy I.P. (2013). Product Recovery Decisions within the Context of Extended Producer Responsibility. *Journal of Engineering and Technology Management Vol 34 pp. 9-28*.
- Kalpajian, S & Schmid, S. R. (2009). *Manufacturing Engineering And Technology Sixth Edition In SI Unit*. Singapore: Pearson.
- Kumaravel, K. (2011). Comparative Study of 3G and 4G in Mobile Technology. *International Journal of Computer Science Issues Vol. 8 pp. 256-259*.

- Marwati, S. (2009). *Kajian Tentang Kandungan Logam-logam Berharga dalam Limbah Elektronik (E-Waste) dan Teknik Recoverynya Melalui Proses Daur Ulang*. Retrieved Februari 22, 2017 from <http://eprints.uny.ac.id/12422/1/49%20Siti%20Marwati>.
- Oscar, N.O. (2016). *11 Fakta Mencengangkan Mengenai E-Waste*. Retrieved Februari 22, 2017 from <http://intisari-online.com/Techno/Green/11-Fakta-Mencengangkan-Mengenai-E-Waste>.
- Ospara, A.W. (2010). *Pengaruh Penambahan SIC terhadap Karakteristik Struktur, sifat termal dan sifat kekerasan dari paduan SNPB*. Jakarta: Grasindo.
- Sale, A. (2013) *Panduan Teknisi ponsel*. Semarang: Qbonk Media Grup.
- Schaub, F. (2014) *Broken Display=Broken Interface?The Impact of Display Damage on Smartphone Interaction*. Canada: Toronto.
- Steinhilper, R. (1998). *Remanufacturing The Ultimate Form of Recycling*. Stuttgart: Fraunhofer IRB Verlag.
- Thierry, M., Salomon, M., Nunen, J.V., dan Wassenhove, L, V. (1995). *Strategic Issue Product Recovery Management*. California: California management Review.
- Widianto,W. (2013). *Indonesia akan kelola produk remanufaktur milik AS*. Retrieved Maret 1, 2017 from <http://www.tribunnews.com/bisnis/2013/04/12/indonesia-akan-kelola-produk-remanufaktur-milik-as>.
- Widarti, D. W & Setyowati, E. (2013). *Aplikasi Sistem Pakar Untuk Mendeteksi Kerusakan Telepon Selular Berbasis Web*. Retrieved Maret 2, 2017. from <http://download.portalgaruda.org/article.php?article=320712&val=6546&title=APLIKASI%20SISTEM%20PAKAR%20UNTUK%20MENDETEKSI%20KERUSAKAN%20TELEPON%20SELULAR%20BERBASIS%20WEB> hal 165-167.